



Product Change Notification

Change Notification #: **117743 - 00**

Change Title: **Select Intel® SSD 660p and Intel® SSD 665p Series Products,
PCN 117743-00, Transport Media, Label,
Box Artwork and Label Updates**

Date of Publication: **August 19, 2020**

Key Characteristics of the Change:

Transport Media, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	September 7, 2020
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Description of Change to the Customer:

The Intel® SSD 660p and Intel® SSD 665p Series SKUs listed in the Products Affected table below will have the following changes:

1. Consumer Unit Label change
 - a. Add KCC logo and certification I.D. to label
 - b. Reposition various fields to allow for space on label



2. Box change to eliminate KCC logo from artwork
 - a. Part number change from K18606-002 to K18606-003
 - b. Remove KCC ID Logo and move to consumer unit label
 - c. Change Copyright date from 2018 to 2020
3. Structural packaging change
 - a. Remove corrugated "wallet" and clamshell
 - b. Replace with new MOQ1 clamshell packaging

Customer Impact of Change and Recommended Action:

There is no change to the form, fit, or function of the product. The change is only to the box artwork and labels used in packaging.

Customers should be aware of the changes to the label and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Post Change TA	Post Change SA
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW512G8X1	978348	K10628-101	K10634-101	K10628-102	K10634-102
Intel® SSD 660p Series (512GB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW512G8XT	978349	K10629-101	K10634-101	K10629-102	K10634-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW010T8X1	978350	K10631-101	K10635-101	K10631-102	K10635-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box Single Pack	SSDPEKNW020T8X1	978351	K10633-101	K10636-101	K10633-102	K10636-102
Intel® SSD 660p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW020T8XT	984872	K31002-101	K10636-101	K31002-102	K10636-102
Intel® SSD 660p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D2, QLC) Retail Box 10 Pack	SSDPEKNW010T8XT	984875	K31001-101	K10635-101	K31001-102	K10635-102
Intel® SSD 665p Series (1.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW010T9X1	999HHA	K54305-100	K52580-100	K31001-102	K10635-102
Intel® SSD 665p Series (2.0TB, M.2 80mm PCIe 3.0 x4, 3D3, QLC) Retail Box Single Pack	SSDPEKNW020T9X1	999HHG	K54306-100	K52581-100	K31001-102	K10635-102

PCN Revision History:

Date of Revision:

August 19, 2020

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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